



TECHNICAL SPECIFICATION

ZMKP-B03LRNC
ZMKP-B30LRNC



V1.0	2026-5-21				
Version	Date	Prepared Designer	Reviewed Supervisor	Approved Branch manager	Accepted

1. General

The SFP+ BIDI transceiver is designed to transmit and receive optical data over SMF for link length 10km. The SFP+ BIDI module electrical interface is compliant to SFI electrical specifications. The transmitter input and receiver output impedance is 100 Ohms differential. Data lines are internally AC coupled. The module provides differential termination and reduce differential to common mode conversion for quality signal termination and low EMI.

2. Features

- Single LC interface, Duplex operation
- Applicable for 10km SMF connection
- Operating data rate up to 11.3Gbps
- Single 3.3V Power supply
- Power consumption $\leq 1.5W$
- Hot-Pluggable SFP+ footprint
- 1270nm/1330nm DFB transmitter, PIN receiver
- Case Operating temperature ranges: 0°C to 85°C
- Compatible with existing CISCO, JUNIPER, NOKIA, HUAWEI, and ERICSSON devices

3. Applications

- 10G BASE-LR/LW
- 10G Ethernet
- CPRI Opt 1~8
- 10G OTU2f

4. Standards

- Compliant to IEEE 802.3ae
- Compliant to SFF-8431
- Compliant to SFF-8472
- SFP+ MSA
- Compliant with EN 55032:2015
- Compliant with IEC 61000-4-2
- Compliant with RoHS

5. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Storage Temperature	T_{stg}	-40	85	°C	-
Case Operating Temperature	T_C	0	85	°C	C-Temp
Relative Humidity - Storage	RH_s	5	95	%	-
Relative Humidity - Operating	RH_o	5	85	%	-
DC Supply Voltage	V_{CC}	-0.3	4.0	V	-

6. Recommended Operating Conditions

Parameter	Symbol	Min	Typ	Max	Unit	Notes
Case Operating Temperature	T_C	0	-	85	°C	-
DC Supply Voltage	V_{CC}	3.135	3.3	3.465	V	-
Module Supply Current	I_{CC}	-	-	450	mA	-
Maximum Power Dissipation	P_D	-	-	1.5	W	-
Data Rate	DR	9.9	-	11.3	Gb/s	-

7. Electrical Characteristics

Parameter	Symbol	Min	Typ	Max	Unit	Notes
TX Single ended data input swing	V_{IN}	180	-	700	mVpp	-
TX Differential Input Impedence	Z_{IN}	80	-	120	Ω	-
RX Single ended data output swing	V_{OUT}	300	-	850	mVpp	-
RX Differential Output Impedence	Z_{OUT}	80	-	120	Ω	-
TX_fault /LOS output (TTL)	V_{OH}	2.4	-	V_{CC}	V	-
	V_{OL}	0	-	0.4	V	-
TX_disable input (TTL)	V_{IH}	2.0	-	V_{CC}	V	-
	V_{IL}	0	-	0.8	V	-

8. Transmitter Optical Characteristics

Parameter	Symbol	Min	Typ	Max	Unit	Notes
Data Rate	DR	-	10.3125	-	Gbps	-
Average Optical Power	P _o	-6	-	-1	dBm	1
Wavelength	λ	1260	1270	1280	nm	2
		1320	1330	1340	nm	3
Extinction Ratio	ER	3.5	-	-	dB	4
Spectral width(@-20dB)	$\Delta\lambda$	-	-	1	nm	-
Side Mode Suppression Ratio	SMSR	30	-	-	dB	-
Optical Return Loss Tolerance	ORLT	-	-	12	dB	-
Pout @TX-Disable Asserted	P _{off}	-	-	-30	dBm	1
RIN _{12OMA}	RIN	-	-	-128	dB/Hz	
Transmitter Reflectance	T _R	-	-	-12	dB	
Eye Mask {X1, X2, X3, Y1, Y2, Y3}	{0.25, 0.40, 0.45, 0.25, 0.28, 0.40}					

Notes :

- 1.The optical power is launched into SMF.
- 2.Represents the ZMKP-B03LRNx transmitting wavelength.
- 3.Represents the ZMKP-B30LRNx transmitting wavelength.
- 4.Measured with a PRBS 2³¹⁻¹ test pattern @10.3Gb/s.

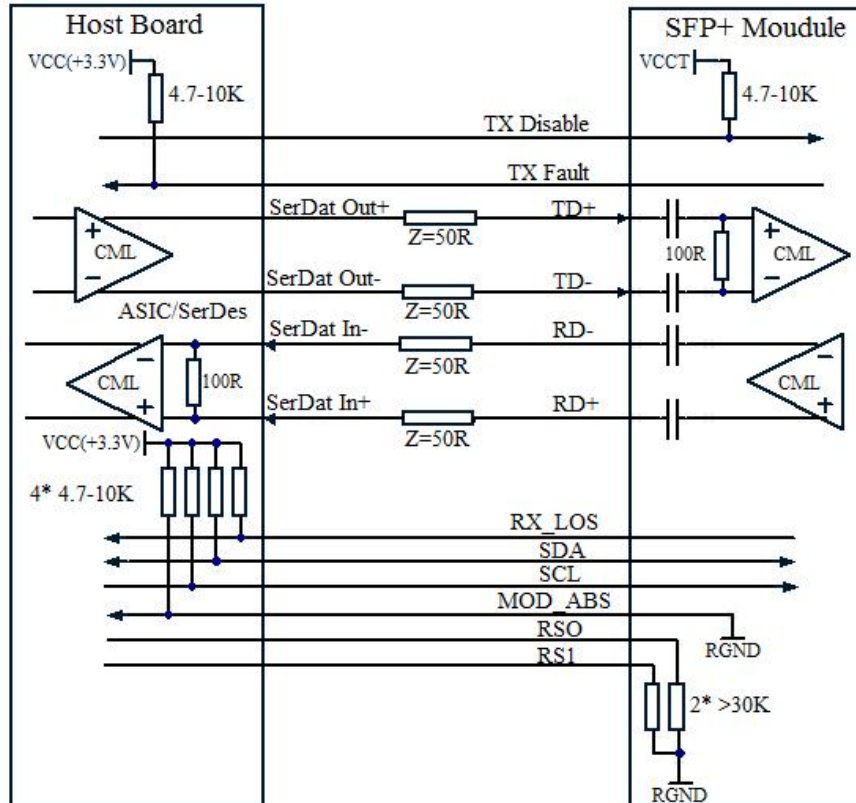
9. Receiver Optical Characteristics

Parameter	Symbol	Min	Typ	Max	Unit	Notes
Data Rate	DR	-	10.3125	-	Gbps	-
Wavelength	λ	1320	1330	1340	nm	1
		1260	1270	1280	nm	2
Average Sensitivity	Sen	-	-	-14.5	dBm	3
Optical Power Overload	PIN	1	-	-	dBm	3
Receiver Reflectance	R _{fl}	-	-	-12	dB	-
LOS De-Assert	LOSD	-	-	-17	dBm	3
LOS Assert	LOSA	-30	-	-	dBm	3
LOS Hysteresis	-	0.5	-	5	dB	3

Notes :

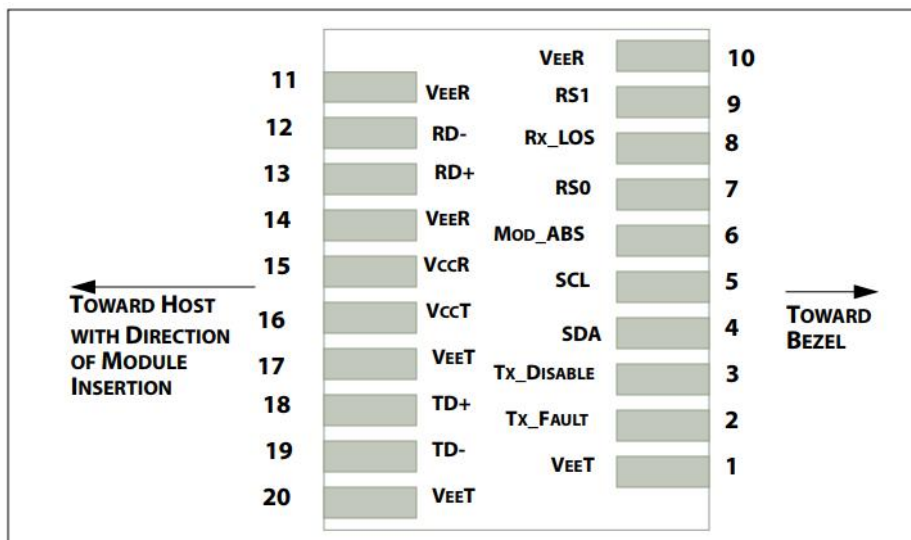
1. Represents the ZMKP-B03LRNx receiving wavelength.
2. Represents the ZMKP-B30LRNx receiving wavelength.
3. Measured with a PRBS 2³¹-1 test pattern, @10.3Gb/s, ER=4.5dB, BER<10⁻¹².

10. Typical Application Circuit



Recommended Application Interface Block Diagram

11. Pin Description



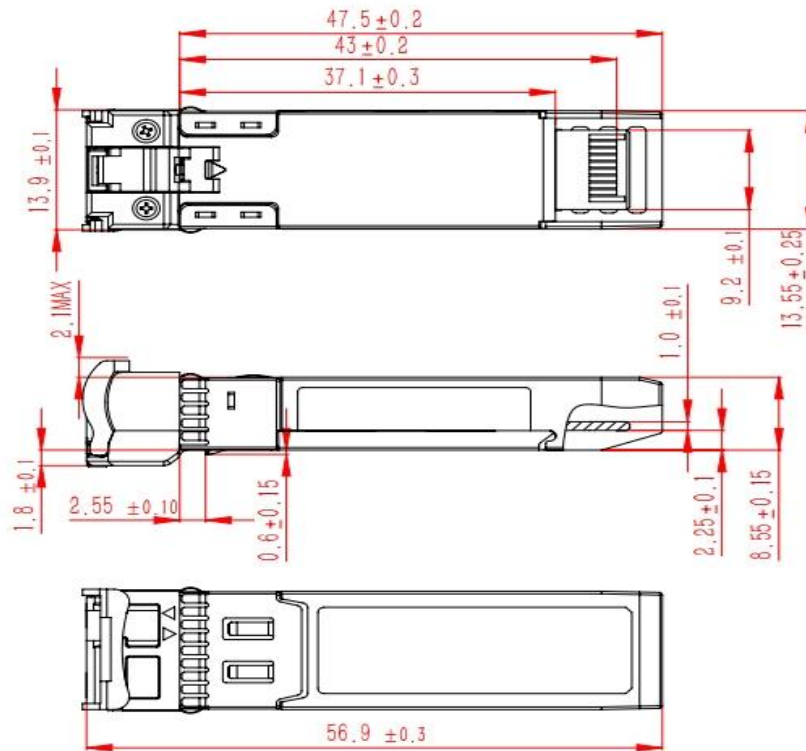
SFP+ pad assignment top view

Pin	Name	Function/Description	Notes
1	VeeT	Transmitter Ground	1
2	TX_Fault	Transmitter Fault (LVTTTL-O) - High indicates a fault condition	2
3	TX_Disable	Transmitter Disable (LVTTTL-I) – High or open disables the transmitter	3
4	SDA	Two wire serial interface Data Line (LVTTTL-I/O) (MOD-DEF2)	4
5	SCL	Two wire serial interface Clock Line (LVTTTL-I/O) (MOD-DEF1)	4
6	MOD_ABS	Module Absent (Output), connected to VeeT or VeeR in the module	5
7	RS0	Rate Select 0 – Not used, Presents high input impedance	6
8	RX_LOS	Receiver Loss of Signal (LVTTTL-O)	2
9	RS1	Rate Select 1 – Not used, Presents high input impedance	6
10	VeeR	Receiver Ground	1
11	VeeR	Receiver Ground	
12	RD-	Inverse Received Data out (CML-O), AC Coupled	
13	RD+	Received Data out (CML-O), AC Coupled	
14	VeeR	Receiver Ground	
15	VccR	Receiver Power - +3.3V	
16	VccT	Transmitter Power - +3.3 V	
17	VeeT	Transmitter Ground	1
18	TD+	Transmitter Data In (CML-I), AC Coupled	
19	TD-	Inverse Transmitter Data In (CML-I), AC Coupled	
20	VeeT	Transmitter Ground	1

Notes:

1. The module signal grounds are isolated from the module case.
2. This is an open collector/drain output that on the host board requires a 4.7K Ω to 10K Ω pull-up resistor to Vcc Host.
3. This input is internally biased high with a 4.7K Ω to 10K Ω pull-up resistor to VccT.
4. Two-Wire Serial interface clock and data lines require an external pull-up resistor dependent on the capacitance load.
5. This is a ground return that on the host board requires a 4.7K Ω to 10K Ω pull-up resistor to VccHost.
6. Rate select can also be set through the 2-wire bus in accordance with SFF-8472 v. 10.2.
Rx Rate Select is set at Bit 3, Byte 110, Address A2h. Tx Rate Select is set at Bit 3, Byte 118, Address A2h.
Writing a "1" selects maximum bandwidth operation. Rate select is the logic OR of the input state of Rate Select Pin and 2-wire bus.

12. Mechanical Dimensions(Unit: mm)



Outline Drawing

Notes:

- 1.Tolerance: +/-0.1mm.
- 2.Light port according with fiber connector SPEC.

13. Ordering Information

Part Number	Specifications						
	Pack	Rate (Gbps)	Tx (nm)	Po (dBm)	Rx	Sen (dBm)	Tc (°C)
ZMKP-B03LRNC	SFP+	10.3125	1270	-6 ~ -1	PIN	-14.5	0 ~ 85
ZMKP-B30LRNC	SFP+	10.3125	1330	-6 ~ -1	PIN	-14.5	0 ~ 85

14. Revision History

Revision	Date	Change information
V1.0	2026-5-21	New Release

15. Warnings

Handling Precautions:

This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Please follow guidelines according to proper ESD procedures.

Laser Safety:

Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation.

Notice:

The information provided on this page contains the product target specifications which are subject to change without notice. For more information ,please check with your ZTT Sales Office for product updates, changes in specifications, sample availability and products release dates.